



# PARA LIGHT ELECTRONICS CO., LTD.

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# DATA SHEET

PART NO.:L-C295JYJGCT

REV: <u>A / 1</u>

CUSTOMER'S APPROVAL:		DCC:	
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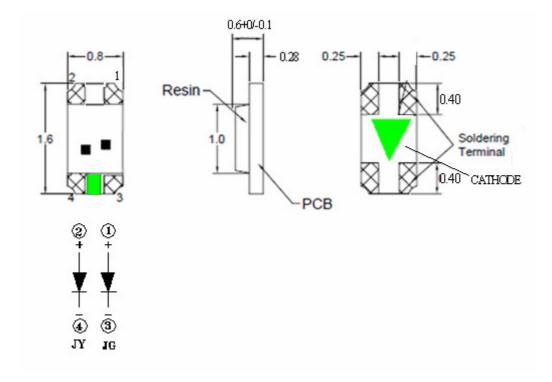




Part No.:L-C295JYJGCT

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#### PACKAGE OUTLINE DIMENSIONS



#### Note:

- 1. All dimensions are in millimeters.
- 2.Tolerance is±0.1mm (.004") unless otherwise noted

#### Features

- \* Dual color, top view, wide view angle Chip LED.
- \* Package in 8mm tape on 7" diameter reels.
- \* Compatible with automatic Pick & Place equipment.
- \* Compatible with Reflow soldering and Wave soldering processes.
- \* EIA STD package.
- \* I.C. compatible.
- \* Pb free product.

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### Chip Materials

chip	Light Color	Dice Material	Lens Color	
JY	Yellow	AlInGap	Water Clear	
JG	Green	AlInGap	water Clear	

# ● Absolute Maximum Ratings (Ta=25°C)

Symbol		Rating		Unit	
Symbol	Symbol Parameter		Green	Ullit	
PD	Power Dissipation	75	60	mW	
Ipf	Peak Forward Current		60	mA	
IPF	(1/10 Duty Cycle, 0.1ms Pulse Width)	80	60	IIIA	
IF	Continuous Forward Current	30	30	mA	
-	De-rating Linear From 25°C	0.25	0.25	mA/°C	
VR	Reverse Voltage	5	5	V	
ESD	Electrostatic Discharge Threshold (HBM) <sup>Note A</sup>	2000	2000	V	
Topr	Operating Temperature Range	-40 ~ +85		$^{\circ}\!\mathbb{C}$	
Tstg	Storage Temperature Range	-40 ~ +85 °C		$^{\circ}\!\mathbb{C}$	
-	Wave Soldering Condition (Two times Max.)	260 (for 5 seconds)		$^{\circ}\mathbb{C}$	

Note A:

HBM: Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

## • Electro-Optical Characteristics (Ta=25°C)

SYMBOL		PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
VF	Yellow	Forward Voltage	IF = 20mA		1.9	2.4	V
VI	Green	-i orward voitage	II = 20111A		2.0	2.4	V
IV	Yellow	Luminous Intensity	IF = 20mA	45	72		med
1 V	Green	-Luminous intensity	IF = 20111A	28	45		mcd
	2θ1/2	Half Intensity Angle	IF = 20mA		130		deg
λD	Yellow	Dominant Wavelength	IF = 20mA		590		nm
, KD	Green	Green Dominant Wavelength II - 2011/A			570		
λр	λρ Yellow Peak Emission Wavelength IF = 20mA			591		nm	
Λρ	Green	- reak Emission wavelength	11 – 201117		571		
Δ.	Yellow	0	IF 00 A		16		nm
Δλ Green		Spectral Line Half-Width	IF = 20mA		15		
IR	Yellow	Reverse Current	VR = 5V			10	Δ
Green		TI TEVELSE GUITEIIL	νη = υν			10	μΑ
			-	•	•		•

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#### Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2.  $\theta$  1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength  $\lambda$  d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Caution in ESD:
  - Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 5. Major standard testing equipment by "Instrument System" Model: CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model: 2400.

### Typical Electro-Optical Characteristics Curves

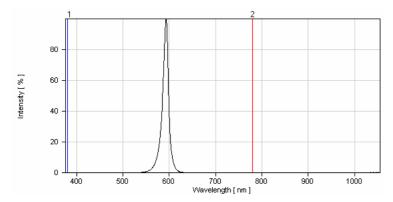


Fig.1 Yellow Relative Intensity vs. Wavelength

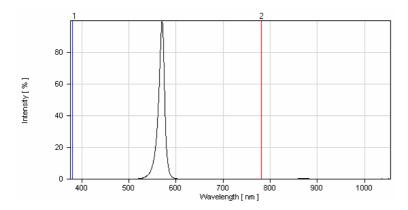


Fig.1 Green Relative Intensity vs. Wavelength

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# Yellow Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

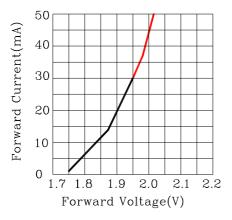


Fig.2 Forward Current vs.Forward Voltage

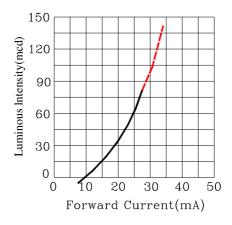


Fig.3 Luminous Intensity vs.Forward Current

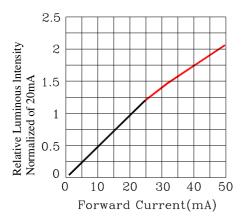


Fig. 4 Relative Luminous Intensity vs.Forward Current

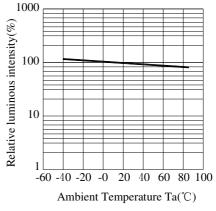


Fig.5 Luminous Intensity vs. Ambient Temperature

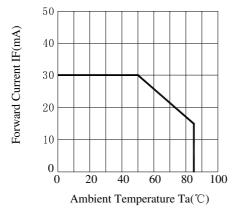


Fig.6 Forward Current Derating Curve

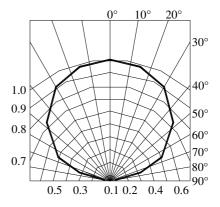


Fig.7 Relative Intensity vs.Angle

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### Green Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

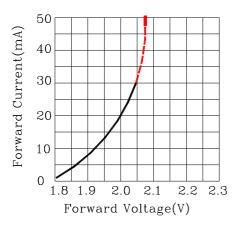
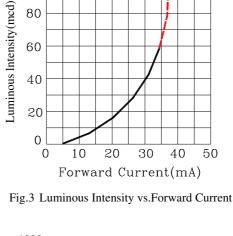


Fig.2 Forward Current vs.Forward Voltage



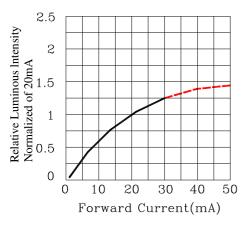


Fig.4 Relative Luminous Intensity vs.Forward Current

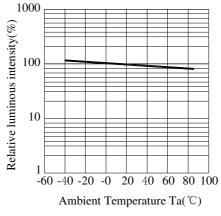


Fig.5 Luminous Intensity vs. Ambient Temperature

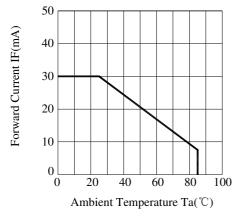


Fig.6 Forward Current Derating Curve

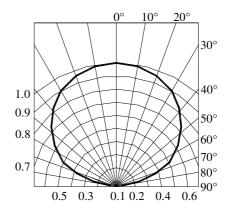


Fig.7 Relative Intensity vs.Angle

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### Label Explanation



ITEM CODE:PARRA LIGHT

PART NO:L-C295JYJGCT

IV --- Luminous Intensity Code

LOT NO: EM S L 12 09 0110
A B C D E F

A---EM: Emos Code

B---S:SMD

L---Local

D---Year

E---Month

F---SPEC.

#### PACKING QUANTITY OF BAG:

3000pcs for 150, 170, 110, 155, 115 series

4000pcs for 191 series

5000pcs for 192 series

DATE CODE: 2012 09 10

G H I

G--- Year

H--- Month

I --- Day

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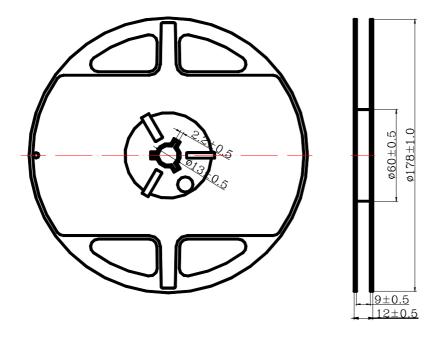




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#### Reel Dimensions



#### Notes:

- 1. Taping Quantity: 4000pcs
- 2. The tolerances unless mentioned is  $\pm 0.1$ mm, Angle  $\pm 0.5^{\circ}$ , Unit: mm.

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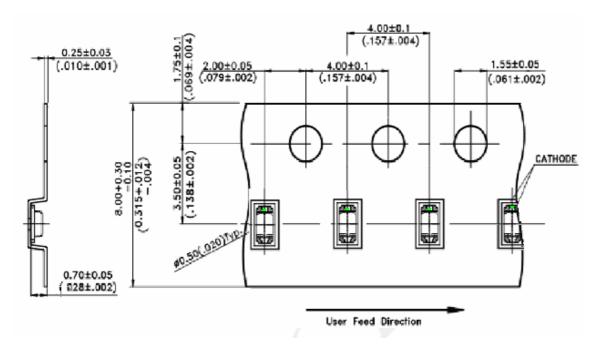




Part No.:L-C295JYJGCT

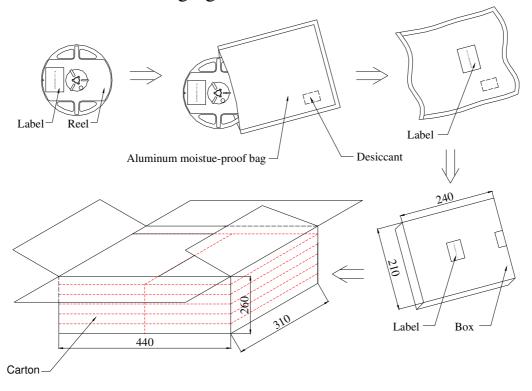
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### Package Dimensions Of Tape And Reel



Notes: All dimensions are in millimeters.

### Moisture Resistant Packaging



Notes: One reel in a bag, six bag in a inner box, six inner boxes in a carton. Unit: mm

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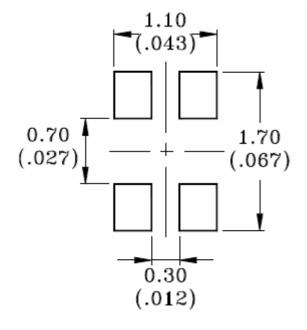
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### Cleaning

- $\star$  If cleaning is required, use the following solutions for less than 1 minute and less than 40°C.
- \* Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- \* Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

### Suggest Soldering Pad Dimensions



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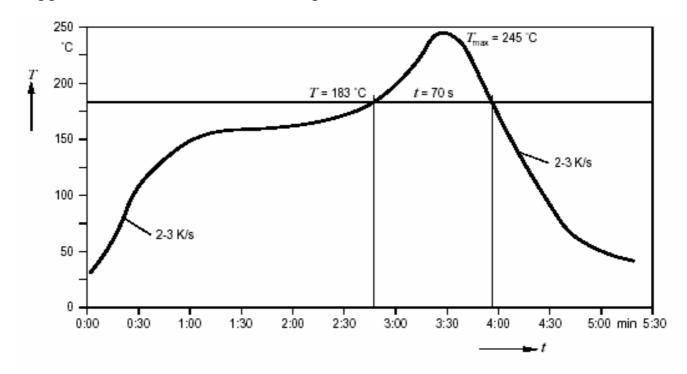




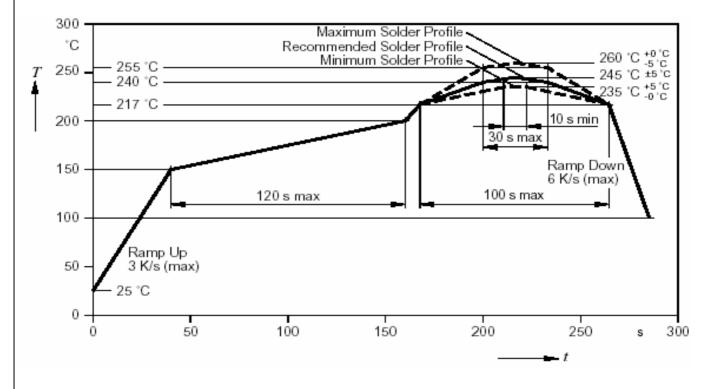
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• Suggest Sn/Pb IR Reflow Soldering Profile Condition:



• Suggest Pb-Free IR Reflow Soldering Profile Condition:



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#### Bin Code List

Luminous Intensity (IV), Unit: mcd@20mA					
Yellow			Green		
Bin Code	Min	Max	Bin Code	Min	Max
P	45	71	N	28	45
Q	71	112	P	45	71
R	112	180	Q	71	112

Tolerance of each bin are  $\pm 15\%$ 

Dominant Wavelength (Hue), Unit: nm@20mA					
Yellow			Green		
Bin Code	Min	Max	Bin Code	Min	Max
YA	587	590	GA	567	570
YB	590	593	GB	570	573
YC	593	596	GC	573	576

Tolerance of each bin are  $\pm 1$ nm

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#### CAUTIONS

#### 1. Application Limitation:

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

#### 2.Storage:

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5°C for 24 hours

#### 3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering condition.

Reflow Soldering:

Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time: 10 sec Max.

Soldering Iron: (Not recommended)

Temperature 300°C Max., Soldering time: 3 sec. Max.(one time only), power dissipation of iron: 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

Wave soldering:

Pre-heat 100°C Max, Pre-heat time 60 sec. Max, Solder wave 260°C Max, Soldering time 5 sec. Max. preformed consecutively cooling process is required between 1st and 2nd soldering processes.

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#### 4. Lead-Free Soldering

#### For Reflow Soldering:

- 1 \ Pre-Heat Temp:150-180°C,120sec.Max.
- 2 · Soldering Temp: Temperature Of Soldering Pot Over 230°C,40sec.Max.
- 3 · Peak Temperature: 260°C , 5sec.
- 4 \ Reflow Repetition: 3 Times Max.
- 5 · Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi /0.5 Cu

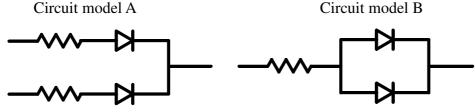
#### For Soldering Iron (Not Recommended):

- 1 · Iron Tip Temp:350°C Max.
- 2 Soldering Iron:30w Max.
- 3 · Soldering Time: 3 Sec. Max. One Time.

#### For Dip Soldering:

- 1 \ Pre-Heat Temp:150°C Max. 120 Sec. Max.
- 2 · Bath Temp:265°C Max.
- 3 \ Dip Time: 5 Sec. Max.

#### 5. Drive Method



(A)Recommended circuit.

(B)The difference of brightness between LED's could be found due to the Vf-If characteristics of LED.

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#### 6.Reliability Test

Classification	Test Item	Test Condition	Reference Standard		
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D: 1026 (1995) MIL-STD-883D: 1005 (1991) JIS C 7021:B-1 (1982)		
Endurance Test	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C,RH= 90~95% *Test Time= 1000HRS±2HRS	MIL-STD-202F: 103B(1980) JIS C 7021: B-11 (1982)		
High Temperatu Storage		Ta= 105±5°C Test Time= 1000HRS (-24HRS, 72HRS)	MIL-STD-883D: 1008 (1991) JIS C 7021:B-10 (1982)		
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS, 72H RS)	JIS C 7021:B-12 (1982)		
Environmental Test	Temperature Cycling	105±5°C -55±5°C 10mins 10mins 100 Cycles	MIL-STD-202F: 107D (1980) MIL-STD-750D: 1051(1995) MIL-STD-883D: 1010 (1991) JIS C 7021: A-4 (1982)		
	Thermal Shock	IR-Reflow In-Board, 2 Times $105\pm5^{\circ}\text{C}$ $-55^{\circ}\text{C}\pm5^{\circ}\text{C}$ $10\text{mins}$ $10\text{mins}$ $100\text{ Cycles}$	MIL-STD-202F: 107D(1980) MIL-STD-750D: 1051(1995) MIL-STD-883D: 1011(1991)		
	Solder Resistance	Tsol= $260 \pm 5^{\circ}$ C Dwell Time= $10 \pm 1$ sec	MIL-STD-202F: 210A(1980) MIL-STD-750D: 2031(1995) JIS C 7021: A-1 (1982)		
	Solder ability	Tsol= $235 \pm 5^{\circ}$ C Immersion time $2\pm 0.5$ sec Immersion rate $25\pm 2.5$ mm/sec Coverage $\geq 95\%$ of the dipped surface	MIL-STD-202F: 208D(1980) MIL-STD-750D: 2026(1995) MIL-STD-883D: 2003(1991) IEC 68 Part 2-20 JIS C 7021: A-2 (1982)		

#### 7.Others:

The appearance and specifications of the product may be modified for improvement without notice.

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